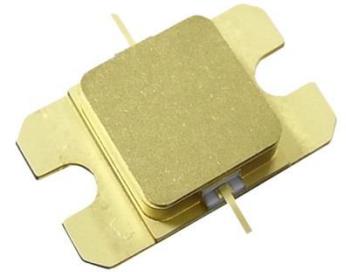


■ Features

- High Output Power: Pout=45.5dBm (Typ.)
- High Linear Gain: GL=11.0dB (Typ.)
- High Power Added Efficiency: PAE=40% (Typ.)
- Broad Band: 10.7 to 11.7GHz
- Impedance Matched Zin/Zout = 50ohm
- Hermetically Sealed Package



■ Description

The SGK1011-25C is a high power GaN-HEMT that is internally matched for standard communication bands to provide optimum power and gain in a 50ohm system.

ABSOLUTE MAXIMUM RATING (Case Temperature T_c=25 deg.C)

Item	Symbol	Rating	Unit
Drain-Source Voltage	V _{DS}	26	V
Gate-Source Voltage	V _{GS}	-10	V
Total Power Dissipation	P _T	97.8	W
Storage Temperature	T _{stg}	-55 to +125	deg.C
Channel Temperature	T _{ch}	+250	deg.C
Case Temperature	T _c	-40 to +125	deg.C

RECOMMENDED OPERATING CONDITION

Item	Symbol	Condition	Limit	Unit
Drain-Source Voltage	V _{DS}		<=24	V
Forward Gate Current	I _{GF}	Rg=100ohm	<=6.8	mA
Reverse Gate Current	I _{GR}	Rg=100ohm	>=-2.1	mA
Channel Temperature	T _{ch}		<+193	deg.C

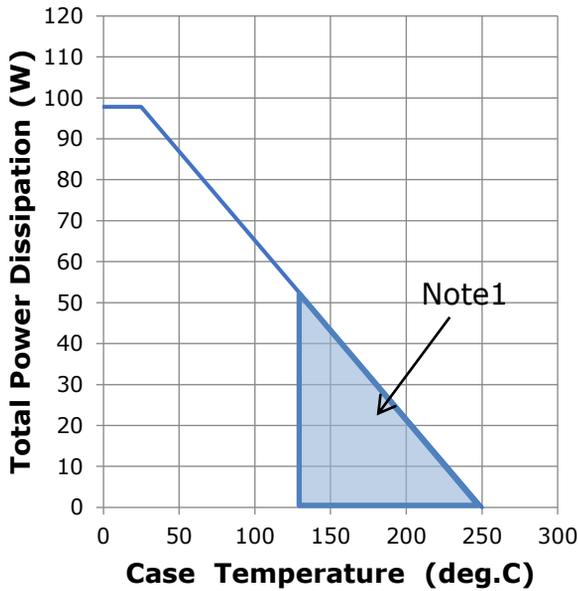
ELECTRICAL CHARACTERISTICS (Case Temperature T_c=25 deg.C)

Item	Symbol	Condition	Limit			Unit
			Min.	Typ.	Max.	
Saturated Drain Current	I _{DSS}	V _{DS} =10V, V _{GS} =0V	-	7.3	-	A
Trans Conductance	G _m	V _{DS} =24V, I _{DS} =0.86A	-	1.9	-	S
Pinch-off Voltage	V _P	V _{DS} =24V, I _{DS} =0.86mA	-2.5	-3.6	-5.5	V
Output Power at 5dB G.C.P.	P _{5dB}	V _{DS} =24V(typ.) I _{DS(DC)} =1.2A(typ.) f=10.7 to 11.7 GHz	43.0	45.5	-	dBm
Linear Gain at Pin=24dBm	GL		9.0	11.0	-	dB
Drain Current at 5dB G.C.P.	I _{DSR}		-	3.0	3.9	A
Power Added Efficiency at 5dB G.C.P.	PAE		-	40	-	%
Gain Flatness	ΔG		-	-	1.6	dB
3rd Order Inter Modulation Distortion	IM ₃	f=10.7GHz, 11.7GHz Δf=10MHz, 2-tone Test Pout=29dBm (S.C.L.)	-37.0	-42.0	-	dBc
Thermal Resistance	R _{th}	Channel to Case	-	1.9	2.3	deg.C/W
Channel Temperature Rise	ΔT _{ch}	(V _{DS} × I _{DSR} - Pout + Pin) × R _{th}	-	90	150	deg.C

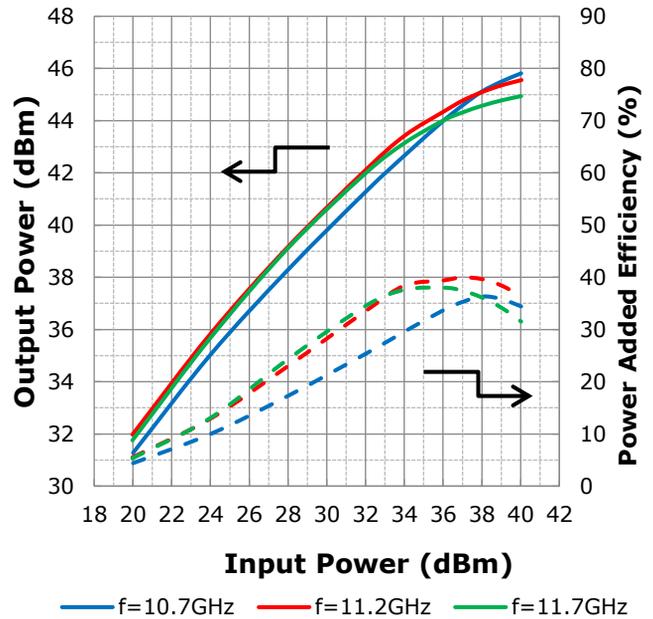
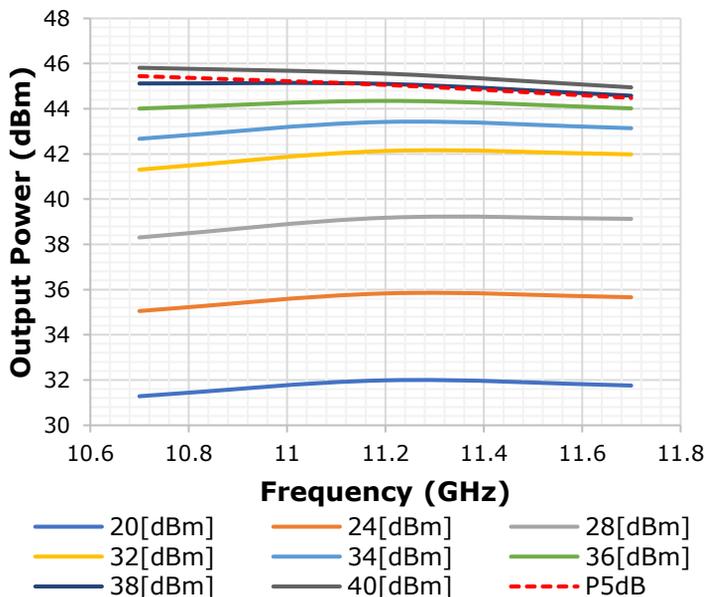
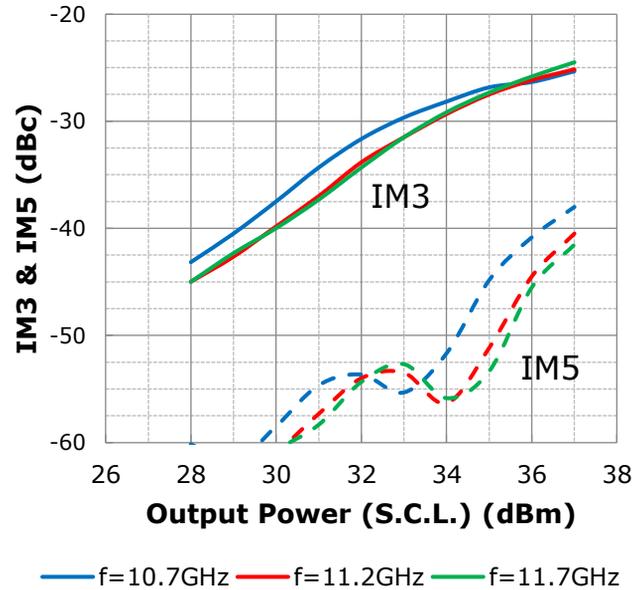
G.C.P. : Gain Compression Point, S.C.L. : Single Carrier Level

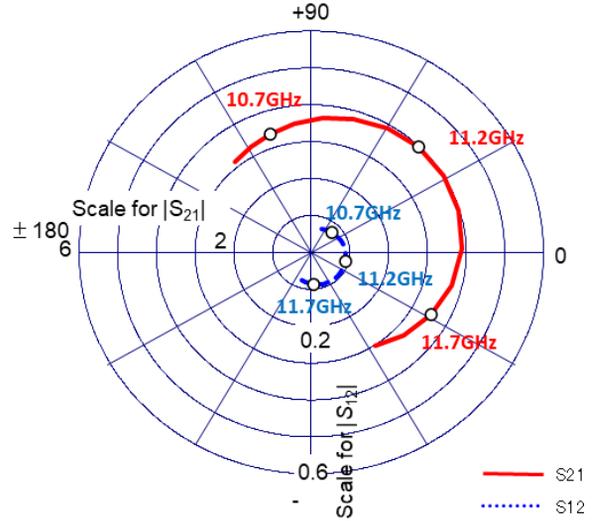
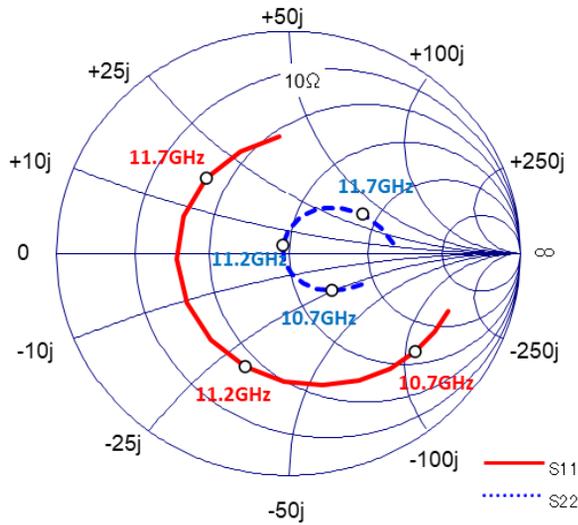
CASE STYLE	IBK
RoHS Compliance	YES
ESD *1	Class 2
	2000V to < 4000V

Note : *1 Based on ANSI/ESDA/JEDEC JS-001-2012(C=100pF, R=1.5kohm)

● RF Characteristics
Power Derating Curve


Note 1: Shaded area exceeds Maximum Case Operating Temperature (See Page1)

Output Power and Power Added Efficiency vs. Input Power
 $V_{DS}=24V, I_{DS(DC)}=1.2A$

Output Power vs. Frequency
 $V_{DS}=24V, I_{DS(DC)}=1.2 A$

IMD vs. Output Power (S.C.L.)
 $V_{DS}=24V, I_{DS(DC)}=1.2 A, \Delta f=10MHz$


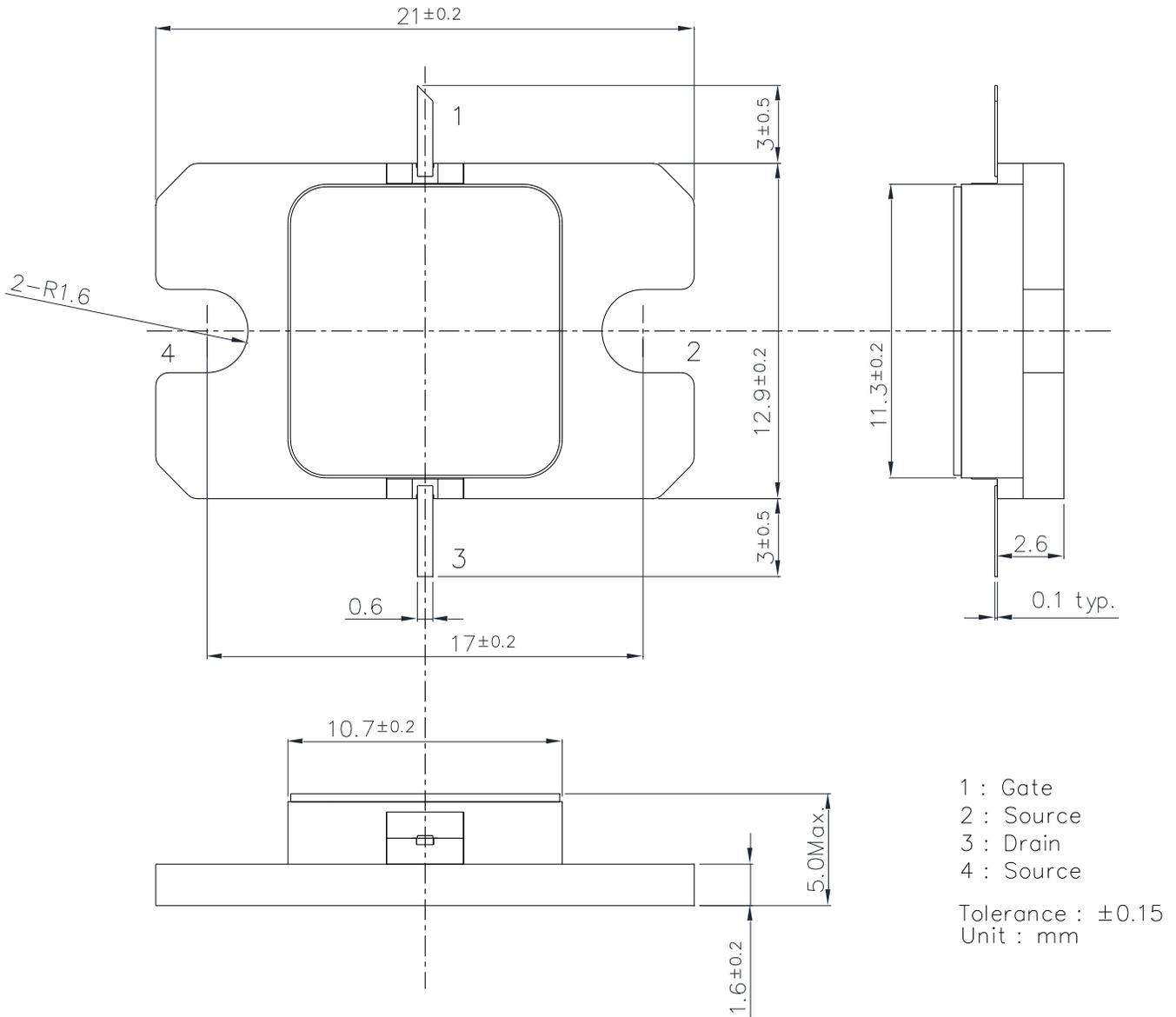
● S-Parameter


Bias Condition $V_{DS}=24V$, $I_{DS(DC)}=1.2A$
 $R_g = 100\text{ohm}$

Freq.	S11		S21		S12		S22	
	mag	phase	mag	phase	mag	phase	mag	phase
10.5GHz	0.737	-20.8	3.152	128.6	0.070	66.6	0.341	-23.8
10.6GHz	0.720	-29.5	3.264	118.4	0.073	56.5	0.298	-32.4
10.7GHz	0.701	-39.1	3.377	108.3	0.077	46.3	0.252	-41.9
10.8GHz	0.677	-49.9	3.525	97.1	0.080	34.9	0.202	-52.2
10.9GHz	0.648	-62.0	3.658	85.4	0.083	23.3	0.148	-64.6
11GHz	0.613	-76.0	3.785	73.1	0.086	11.3	0.093	-80.5
11.1GHz	0.576	-92.0	3.899	59.6	0.089	-1.6	0.038	-118.6
11.2GHz	0.542	-110.3	3.976	45.9	0.091	-14.8	0.045	125.6
11.3GHz	0.511	-130.5	4.001	31.4	0.093	-28.2	0.107	91.1
11.4GHz	0.489	-153.0	3.976	16.6	0.093	-42.6	0.175	72.3
11.5GHz	0.480	-176.7	3.890	1.6	0.092	-57.1	0.242	56.7
11.6GHz	0.480	159.6	3.729	-13.8	0.090	-71.7	0.305	42.3
11.7GHz	0.489	136.3	3.540	-28.6	0.087	-86.5	0.362	29.1
11.8GHz	0.503	114.4	3.276	-43.2	0.082	-101.0	0.414	16.5
11.9GHz	0.530	94.3	3.025	-57.0	0.077	-114.5	0.458	4.9

● Package Out line

Case Style : IBK



For Safety, Observe the Following Procedures Environmental Management

- Do not put this product into the mouth.
- Do not alter the form of this product into a gas, powder, or liquid through burning, crushing, or chemical processing as these by-products are dangerous to the human body if inhaled, ingested, or swallowed.
- Respect all applicable laws of the country when discarding this product.
This product must be disposed in accordance with methods specified by applicable hazardous waste procedures.

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